

Elecolit®
Electrically and Thermally Conductive Adhesives

- TCA: thermally conductive adhesives
- ICA: isotropically conductive adhesives
- ACA: anisotropically conductive adhesives
- 1-part and 2-part epoxies
- Suitable for manual production and automated production lines
- Application with dispenser, screen printing and pin transfer possible
- UV-curing or curable at room and/or high temperature
- Easy to process

Elecolit® Conductive Adhesives – Always the Right Connection

Elecolit® is our brand of electrically and thermally conductive adhesives.

The products of the Elecolit®-series are an innovative solution for many applications.

Elecolit® conductive adhesives are synthetic resins filled with metallic or inorganic filler materials.

The Portfolio Comprises:

- ICA isotropically conductive adhesives
- TCA thermally conductive adhesives
- ACA anisotropically conductive adhesives

1-Part Products

Benefits: simple processing with dispenser, screen printing or needle transfer – no mixing required.

2-Part Products

Benefits: long shelf life, curing at room temperature possible, very short curing times possible at higher temperatures, low-viscosity settings possible.

Electrically Conductive

Our electrically conductive products contain metallic fillers such as silver or graphite. The more filler material the product contains, the higher is its conductivity.

Applications

- Die bonding
- Antennae contacting
- Flip-chips
- Anisotropically conductive connections
- HF shielding
- 3D-MID

Advantages As Compared to Other Techniques:

- Lead- and solvent-free
- Curing at low temperatures < 120 °C
- Easily incorporated into existing assembly processes
- High flexibility at temperature shock
- High thermal stability
- No bleeding

Electrically Conductive Adhesives

Elecolit®	3024	3012	3043	3653	3655	3025	3036
Typical Applications	Heat-Sensitive Components	Chips & Electrical/Electronic Components	Antenna Printing, Ceramic Fuses	Flexible Component Bonds	Die-Attach, Semi Conductor, Part Assembling	Suitable for Heat Sensitive Parts	Suitable for Heat Sensitive Parts
Base	2-part Epoxy	1-part Epoxy	1-part Epoxy	1-part Epoxy	1-part Epoxy	2-part Epoxy	2-part Epoxy
Viscosity (mPas)	2,800	Pasty	4,000 – 5,000	8,000 – 10,000	15,000 – 45,000	Pasty	Pasty
Curing	15 min at 120 °C	10 min at 150 °C	10 min at 150 °C	5 min at 150 °C	30 min at 150 °C 60 min at 120 °C	24 h at RT 15 min at 120 °C	24 h at RT 15 min at 120 °C
Temp. Resist. (°C)	-40 to +150	-40 to +200	-40 to +180	-40 to +180	-40 to +180	-40 to +150	-40 to +150
Contact Resistance ohms x cm	0.0005	0.013	0.015	0.005	0.0003	0.05	0.1
Special Properties	Snap Cure at High Temperatures, Pot Life: 8 h, Cures at as Low as 80 °C	Dispenser, Screen Printing, Very Good Conductivity, Excellent Gap Filling Properties	Very low Viscosity, Easy to Dispense, Fine Grade Fillers Ag <10µm, Low Ionic Content	Highly Flexible, Temperature-, Vibration- and Impact-Resistant, Easy to Dispense	Easy to Dispense, Fine Grade Fillers (<10µm), High Thermal Conductivity, High Electrical Conductivity	Curing at RT Possible, Short Production Time at High Temperatures, Dispensable, Screen Printable	Curing at RT Possible, Short Production Time at High Temperatures, Dispensable, Screen Printable

Electrically Conductive Adhesives

Elecolit®	323	325	336	327	342	414
Typical Applications	Component Bonding/ Electronics	Heat-Sensitive Components	Heat-Sensitive Components	High-Temperature Range	Electrically Conductive Contacts, HF Shielding	Flexible Conductive Paths on Film
Base	2-part Epoxy	2-part Epoxy	2-part Epoxy	1-part Polyimide	1-part Acrylate	1-part Polyester
Viscosity (mPas)	45,000	Paste-like	Paste-like	8,500	1,000 – 2,000	20,000 – 25,000
Curing	4 min at 150 °C	5 min at 150 °C	5 min at 150 °C	1 h at 150 °C	10 min at 120 °C	5 min at 150 °C
Temp. Resist. (°C)	-60 to +175	-40 to +150	-40 to +150	-40 to +275	-40 to +150	-55 to +200
Contact Resistance ohms x cm	0.0002	0.0005	0.001	0.0001	0.001	0.0005
Special Properties	Pot Life 96 hours, Cures at Low Temperatures, Suitable for Semiconductors, Easily Dispensed	Fast Curing at High Temper., Dispensers, Printing and Screen Printing, Very Good Conductivity	Cures at Room and Low Temperatures, Dispenser, Printing and Screen Printing, Inexpensive	High Electrical & Thermal Conductivity, Good Adhesion to Gold, Aluminium, Tantalum, Germanium and Ceramics	Latex-like Film, Low Mechanical Strength, Good Adhesion to Many Substrates, Curing at Room Temp. Possible	Extremely Flexible, Very Good Conductivity, Can be Folded or Coiled, Abrasion-Proof

Thermally Conductive

The highest thermal conductivity can be achieved with metallic fillers, which are not only thermally but also electrically conductive. If only thermal conductivity is needed, non-metallic filled products should be utilized.

Applications

Applications that release heat energy:

- Bonding of power modules
- Bonding of heat sinks

Advantages As Compared to Other Techniques:

- Simultaneous dissipation of high thermal energy and mechanical fixation in contrast to pastes
- Solvent-free
- Fast curing
- High purity and low ionic content
- 1-part, easy processing

Processing

Elecolit® products are versatile and reliable, even under extreme conditions.

- Suitable for manual production and automated production lines
- Processing with dispenser, screen printing and pin transfer

Certified Quality

Our adhesives do not contain heavy metals and comply with RoHS, WEEE and REACH directives.

Customized Solutions for Unique Applications

Panacol provides innovative solutions for your needs: All adhesives can be individually tailored and tuned to your special requirements.

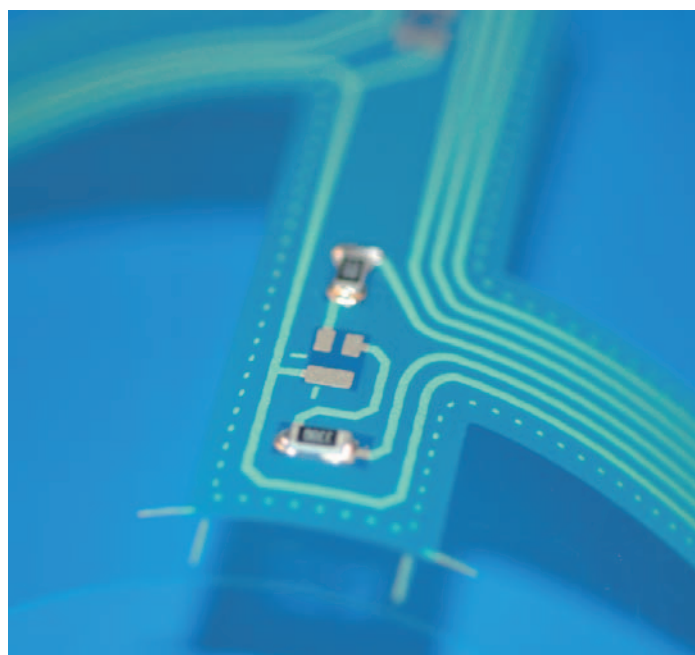
For further information please contact us at info@panacol.de.

Thermally Conductive Adhesives

Elecolit®	6601	6603	6604			6616	6207
Typical Applications	Heat Sinks, Sensors	Bonding Magnets and Heat Sinks	Sensors for Measuring Instruments			Sealant for Curing at Room Temperature	Capsule and Sealant
Base	1-part Epoxy	1-part Epoxy	1-part Epoxy			2-part Epoxy	2-part Epoxy
Viscosity (mPas)	12,000 – 20,000	95,000 – 115,000	110,000 – 140,000			Pasty	9,000 – 12,000
Curing	20 min at 150 °C	20 min at 150 °C	10 min at 150 °C			2 h at 80 °C	2 h at 65 °C
Temp. Resist. (°C)	-40 to +200	-40 to +200	-40 to +200			-50 to +150	-55 to +110
Heat Conductivity (W/mK)	1.05	1.3	1.05			1.01	0.9
Special Properties	Very Good Adhesion to Metals, Excellent Flow Behaviour, High Strength, Good Dispensability	Slightly Flexible, Impact- and Temperature-Resistant, High Viscosity	Low Heat Expansion, No Influence on Transmitted Signals, High Viscosity			Pot Life 45 min, Flexible at Low Temperatures, Vibration- and Impact-Resistant, Visco-Plastic	Low Viscosity, Flame-Retardant, Low Shrinkage, Pot Life 2 hours, UL 94 V0

Anisotropically Conductive Adhesives

Elecolit®	3063	3064	3065
Typical Applications	Flexible Circuits	Flexible Circuits	Display/ Touch Panel
Base	1-part UV Acrylate	1-part UV Acrylate	1-part UV Acrylate
Viscosity	Thixotropic	Thixotropic	Thixotropic
Curing	15 sec/2000mW/cm ² + 1,5 N/cm ²	15 sec/2000mW/cm ² + 1,5 N/cm ²	15 sec/2000mW/cm ² + 1,5 N/cm ²
Temp. Resist. (°C)	-40 to +150	-40 to +150	-50 to +150
Heat Conductivity (W/mK)	0.001	0.001	0.001
Special Properties	Anisotropic, UV-Curing, for Transparent Film with Printed Conductive Paths, Highly Flexible	Anisotropic, UV-Curing, for Transparent Film with Printed Conductive Paths, Highly Flexible, Alternative to EI 3063	Anisotropic, UV- and Heat Curing, for Transparent Film with Printed Conductive Paths, Highly Flexible, Dual Curable for Larger Connector Sizes



Perfect Curing of Adhesives and Sealing Compounds with High Performance UV Equipment by Hönle

Dr. Hönle AG is one of the world's leading suppliers of industrial UV technology. Innovative Hönle UV systems have been applied worldwide – as gas discharge lamps and also as LED versions.

Hönle und Panacol attach great importance to joint research and development. They have combined their knowledge and extensive experience, which has led to comprehensive high-tech solutions for bonding applications.

Hönle UV-LED Curing Technology for Anisotropic Conductive Adhesives

UV-LED lamps by Hönle are the perfect choice for UV curing anisotropic conductive adhesives. The spectrum of our LED devices is accurately adjusted to the absorption of Elecolit®-products by Panacol.

The result is a fast and safe curing. By using LEDs there's only low heat impact on the substrate, which prevents from thermal damage. According to the size of the substrate either a point source or a flood unit is applied.

bluepoint LED eco

The point source bluepoint LED eco has been developed for all applications requiring a most intensive UV irradiation. Thanks to its high intensity and the capability to program complete process



bluepoint LED eco

sequences, e.g. exposure series with different intensities and holding times, it is possible to realize very short cycle and machine throughput times, especially in fully automated production lines.

LED Powerline

LED Powerline is a high-performance array with all advantages of LED technology: LEDs have an extremely long lasting lifetime and do not require heating up or cooling phases.

LED Powerline is available in wavelengths of 365/385/395/405nm. This variety allows an exact adjustment of the wavelength to the respective application.

The LED array is available in different lengths from 80mm – in 40mm-steps variable – up to a length of > 1m.

New is a LED Powerline version with focusing lenses.

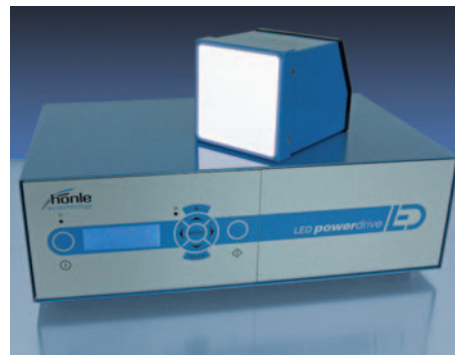
They allow highest intensities, even if – due to the component architecture – only a larger distance between LED unit and curing spot is possible.



LED Powerline

LED Spot 100

LED Spot 100 has been developed for all applications requiring a highly intensive UV irradiance over a large area, which can option-



LED Spot 100

nally be enlarged by connecting several LED Spots 100 without any gaps.

The arrangement of the LEDs as well as an electronic power control guarantees a homogenous irradiation.

The recognition of LED-malfunction and a comprehensive monitoring function provide very high process stability.

hönle group		Engineered Adhesives	UV-adhesives	Conductive adhesives	Potting	Curing
aladin	eleco-efd	eltosch	grafix	hönle	mitronic	panacol
			printconcept	raesch	uv-technik speziallampen	



Panacol-Elisol GmbH, Daimlerstr. 8, 61449 Steinbach/Taunus, Germany
Phone: +49 6171 6202-0, Fax: +49 6171 6202-590, email: info@panacol.de. www.panacol.com

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